

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_b
150V	19mΩ@10V	60A
	22mΩ@6V	

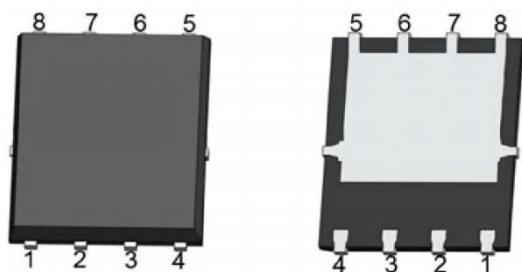
Feature

- Advanced trench cell design
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$

Application

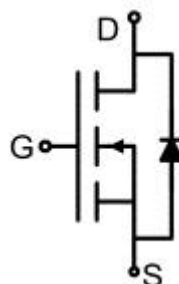
- Power switching application
- Uninterruptible power supply
- DC-DC convertor

Package

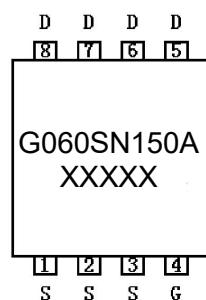


PDFN5*6-8L

Circuit diagram



Marking



Absolute maximum ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 25	V
Continuous Drain Current ($T_C=25^\circ\text{C}$)	I_D	60	A
Continuous Drain Current ($T_C=100^\circ\text{C}$)	$I_{D(100^\circ\text{C})}$	38	A
Pulsed Drain Current ¹⁾	I_{DM}	120	A
Power Dissipation ²⁾ ($T_C=25^\circ\text{C}$)	P_D	125	W
Thermal Resistance Junction to Case	$R_{\theta JC}$	1	$^\circ\text{C/W}$
Operating Junction Temperature	T_J	-55 ~ +150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Electrical characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu\text{A}$	150			V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=150V, V_{GS}=0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 25V$			± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2		4	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$		13	19	m Ω
		$V_{GS}=6V, I_D=10A$		15	22	
Dynamic characteristics³⁾						
Input Capacitance	C_{iss}	$V_{DS}=75V, V_{GS}=0V, f=1\text{MHz}$		2100		pF
Output Capacitance	C_{oss}			160		
Reverse Transfer Capacitance	C_{rss}			5		
Total Gate Charge	Q_g	$V_{DS}=75V, V_{GS}=10V, I_D=20A$		25		nC
Gate-Source Charge	Q_{gs}			10		
Gate-Drain Charge	Q_{gd}			8		
Turn-on delay time	$t_{d(on)}$	$V_{DS}=75V, V_{GS}=10V, I_D=20A$ $R_G=4.5\Omega$		15		nS
Turn-on rise time	t_r			34		
Turn-off delay time	$t_{d(off)}$			30		
Turn-off fall time	t_f			26		
Source-Drain Diode characteristics						
Diode Forward Current	I_S				60	A
Diode Forward voltage	V_{SD}	$V_{GS}=0V, I_S=20A$			1.3	V
Reverse Recovery Time	T_{rr}	$I_F=20A, di/dt=-100A/\mu\text{s}$		86		nS
Reverse Recovery Charge	Q_{rr}			220		nC

Notes:

- 1) Repetitive rating; pulse width limited by max. junction temperature.
- 2) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 3) Guaranteed by design, not subject to production testing.

Typical Characteristics

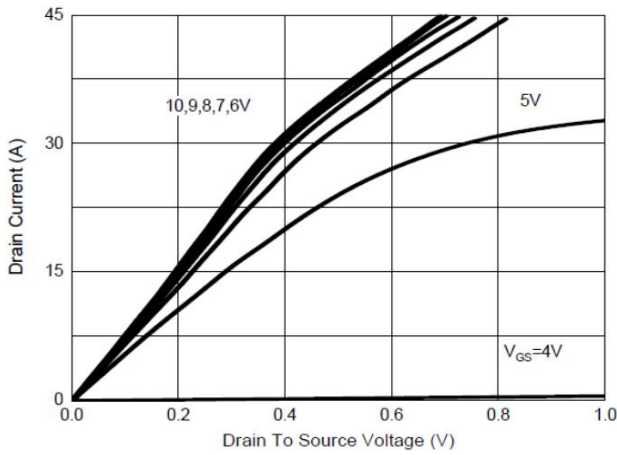


Figure 1. Output Characteristics

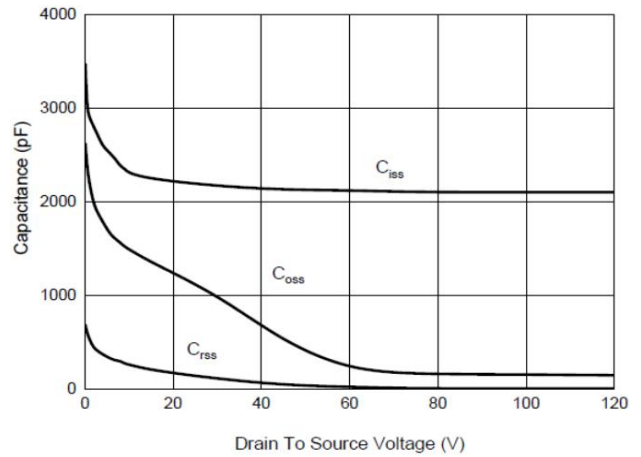


Figure 2. Capacitance Characteristics

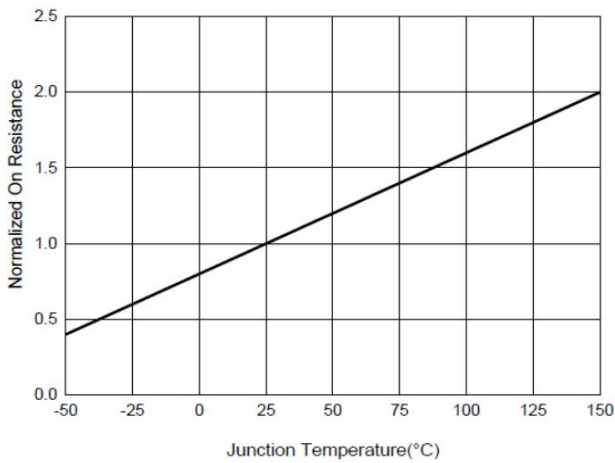


Figure 3. Normalized On-Resistance

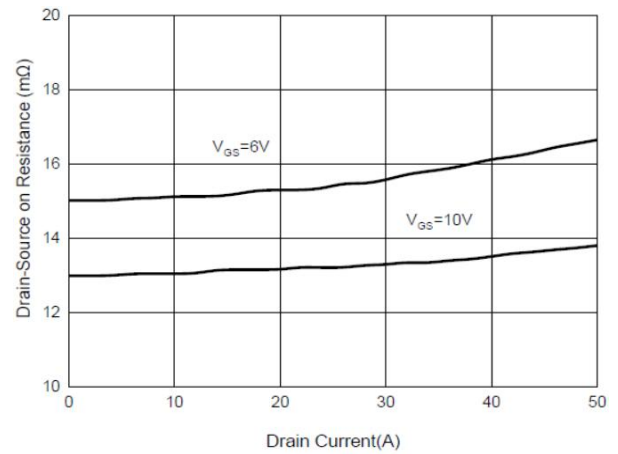


Figure 4. R_{DS(on)} VS Drain Current

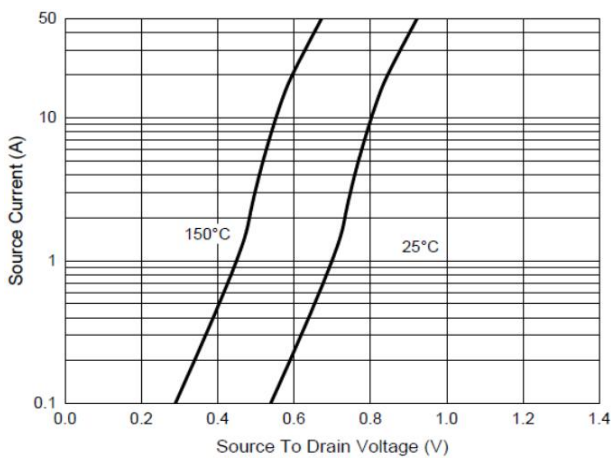


Figure 5. Forward characteristics of reverse diode

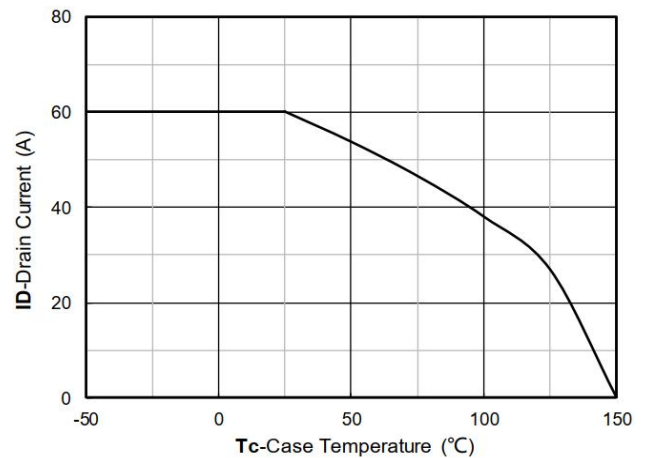


Figure 6. Power dissipation

Typical Characteristics

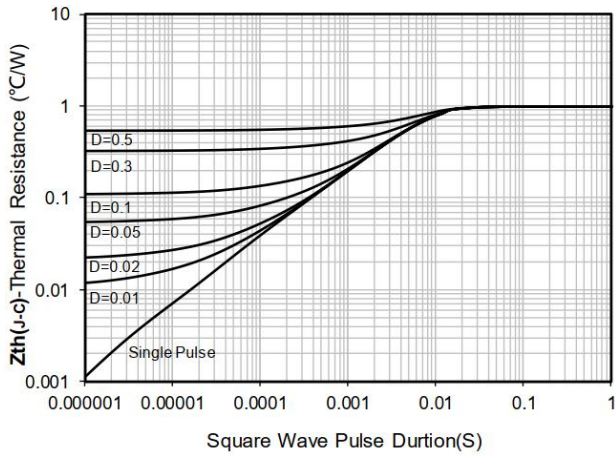


Figure 7. Maximum Transient Thermal Impedance

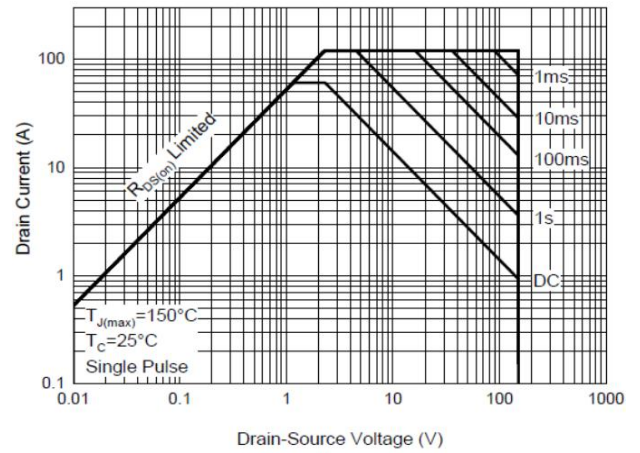
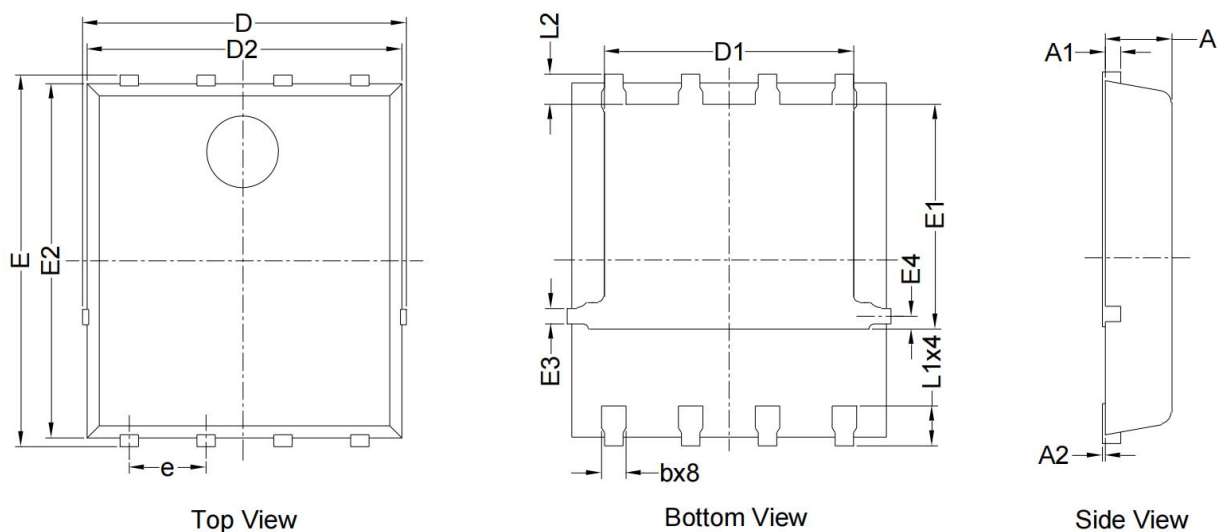


Figure 8. Safe Operation Area

PDFN5*6-8L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
D	5.150	5.550	0.203	0.219
E	5.950	6.350	0.234	0.250
A	1.000	1.200	0.039	0.047
A1	0.254 BSC.		0.010 BSC.	
A2	0.000	0.100	0.000	0.004
D1	3.920	4.320	0.154	0.170
E1	3.520	3.920	0.139	0.154
D2	5.000	5.400	0.197	0.213
E2	5.660	6.060	0.223	0.239
E3	0.254 REF.		0.010 REF.	
E4	0.210 REF.		0.008 REF.	
L1	0.560	0.760	0.022	0.030
L2	0.500 BSC.		0.020 BSC.	
b	0.310	0.510	0.012	0.020
e	1.270 BSC.		0.050 BSC.	